Sticking and mold control

TIA Tech 2017
Los Angeles, California
Steve Bright

Sticking – Package

- Sticking Defined:
 - Two or more tortillas that will not separate from each other without tearing or ripping after being packaged for any period of time.
- Sticking can be caused by several factors
 - Process
 - Ingredients
 - Formulation.

Sticking - Process Related Causes

- Mixing over mixed
 - Rare to see tortilla doughs over mixed
 - Physically / mechanically ruptures protein
 - Gluten releases water
 - Hot dough temperatures
- Under mixed
 - Under-hydrated
 - Poor gluten hydration / development
 - Less absorption

Sticking - Press Setup

- Dry, stiff doughs require increased pressure, dwell time and temperature to obtain correct sizes
 - ★ gelatinizes (cooks) starch, sets structure
 - × activates all leavening
 - creates top and bottom crust which entrains steam increasing the likelihood of pillowing (puffing)
- Ideal press settings
 - ✓ dwell time = $^{1.3}$ seconds +/-0.2
 - ✓ pressure = ~ 1000 psi +/- 200
 - \checkmark temperature = ~375 / 400 +/- 25°F
 - ✓ New Mega Presses = < 325°F

Baking Profile

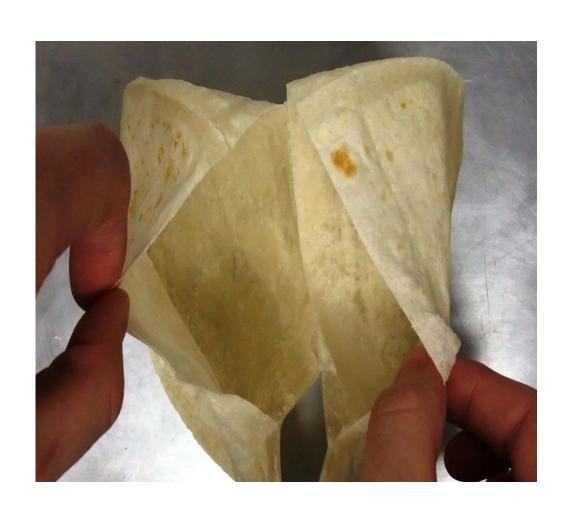
- Under baking
 - Excess residual moisture
 - Insufficient surface drying



- top -thin crust separates from thick -bottom crust
- thin crust and blisters are weak
 - tear and flake



Over baking



U V U I





Sticking Cooling room

- Purpose of the cool down is to fully prepare the tortilla for packaging, transportation and storage
- Typical cooler conditions
 - cool and HUMID, 35 40° F @80%+RH
 - Room is cool and wet causing mist / dew / fog to condense back on the tortilla
- Cooler conditions must be adjusted to obtain:
 - Tortilla pack temperature +/- 10°F package room
 - Humidity < 60%RH critical</p>

Sticking - Packaging

- Minimize temperature shifts after packaging
 - promotes moisture migration
 - 80°F packing into case
 - 50 -100°F warehouse temperature
 - 20 140°F truck shipping temperature winter / summer
 - 70°F grocery store temperature
 - 40°F consumer refrigeration
- Avoid excessive compression
 - over-packing
 - excessive weight

Sticking -Ingredient causes

- Flour weak flour
 - poor gluten quality, although quantity may be available
 - translates to:
 - poor dough process tolerance
 - weak baked film formation
 - poor resistance to compression
- Strong Flour
 - enhances pillowing better gas retention

Sticking - Reducing Agents

- L-Cysteine and Sodium Metbisulfite
 - greater extensibility in the dough
 - higher levels (>60ppm) lead to weak protein and crust resilience.
 - Increases the occurrence of sticking

Obtain dough consistency through full mix development

Sticking –Fat effect

Type of fat being used is critical:

- Liquid oils remain liquid at room temperature
 - Increases surface adhesion on the tortilla
 - Liquid oils will always create point far zippering
 - Use drigbrerososidsvatsroomg
 oil temperature





Sticking -Water

- Case Study
 - Tortilla plant ran water trials from 55% 38%
 - Still had sticking at 38%
 - Its not the quantity of water that's the problem
 - Water is both a strengthener and a tenderizer
 - Hydrates protein
 - Hydrates Gums
 - Higher viscosity gums may continue to hydrate for 48 hours if insufficiently hydrated during mixing
 - Temperature is critical to rate of hydration
 - Cooler = cold, sticky, bucky dough
 - Warmer = Sticky, extensible doughs

Sugar and sticking

- Sugar is a tenderizer
- Sugar is hygroscopic
- As sugar increases, hygroscopicity increases
 - increases stickiness and tenderness.
 - Dextrose, glucose, fructose and lactose are hygroscopic

Microbial stability

- SOURCES
- SOLUTIONS

Sources of mold contamination

- Ingredients, specifically FLOUR, GRAINS
- Air:
 - Atmospheric plants require positive air flow fscreened through HEPA Filter
 - Compressed air must be monitored
- Environmental testing, especially doorways, trash areas, packaging area and cooling room, points of air ingress.
- Test equipment specifically cooling and packaging
- People hands

Conditions for mold growth

- Temperature: mold grows best at 80 F (27C) degrees and 80 percent relative humidity
- pH: mold likes slightly acid conditions (6-7)
- Respiration: oxygen, carbon, hydrogen, nitrogen
- Moisture: higher water activity promotes mold growth (.87 to 1.0)
- Time: Mold can appear in 2 to 5 days

Mold Inhibitors

- Potassium sorbate: Potassium salt of Sorbic Acid
 - Inhibits yeast, mold and some bacteria.
 - Used in chemically leavened products 0.2 0.5 % flour basis
- Sorbic acid:
 - Added benefit of reducing pH
 - Low solubility water < 120°F
- Natural cultured, fermentation producing organic acids

Mold inhibitors - Artificial

- Calcium propionate: Calcium salt of propionic acid
- Inhibits mold, bacteria BUT NOT YEAST
 - Free flowing powder or crystal
 - Used at 0.2 0.5 % flour basis.
 - Functional pH < 5.5</p>

Mold Inhibitors

- Sodium propionate: Sodium salt of propionic acid
 - Used more in chemically leavened products, since calcium may delay the reaction of baking powders
 - Hygroscopic
 - Functional pH < 5.5</p>

Acidulants used in tortillas

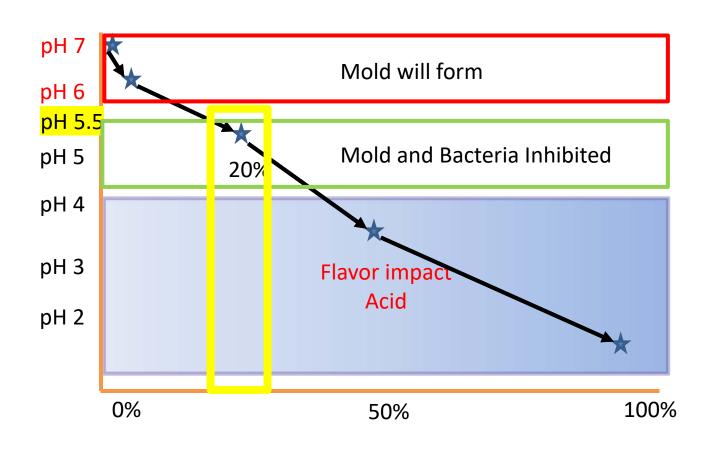
- Best solution:
- Fumaric acid
 - Hot water soluble inhibits pre-reaction with baking powder
- Other solutions
- Malic, Citric, Adipic, Tartaric, Acetic (vinegar),
 Phosphoric
 - All will affect flavor and texture
- Encapsulation will help retard the baking powder prereaction.

Microbial Stability

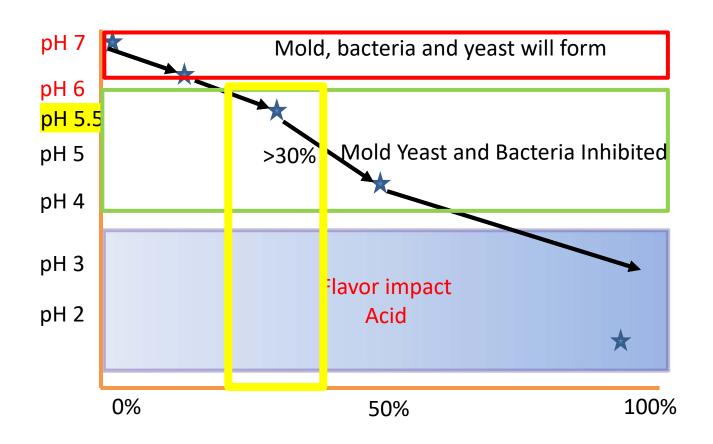
- Balance between:
 - Shelf life expectations
 - pН
 - Preservatives
 - Homogenized ingredients



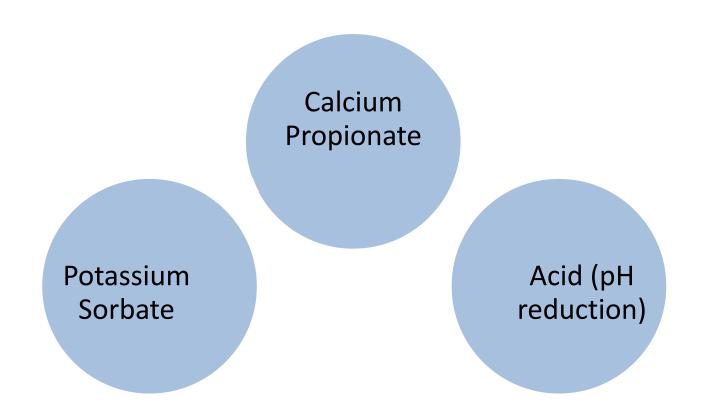
Effectiveness of calcium propionate at different pH levels



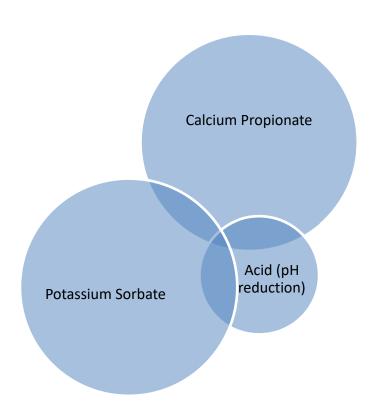
Effectiveness of sorbic acid different pH levels



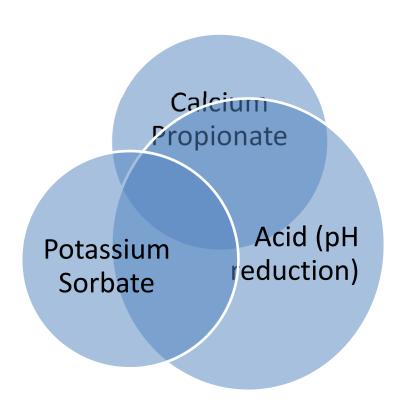
Preventing mold – ingredients Three legged stool



Preventing mold – ingredients Three legged stool



Preventing mold – ingredients Three legged stool



Control of mold

- Minimize contamination of product with mold
- Control factors that enhance mold growth
- Establish clear expected shelf life
- Usage of mold inhibitors balance preservation system
 - Natural
 - Artificial
- Optimize acids and pH